Features

- Programmable 16,777,216 x 1-bit Serial Memories Designed to Store Configuration Programs for Field Programmable Gate Arrays (FPGAs)
- 3.3V Output Capability
- 5V Tolerant I/O Pins
- Program Support using the Atmel ATDH2200E System or Industry Third Party Programmers
- In-System Programmable (ISP) via 2-wire Bus
- Simple Interface to SRAM FPGAs
- Compatible with Atmel AT40K and AT94K Devices, Altera FLEX[®], APEX[™] Devices, Lucent ORCA[®] FPGAs, Xilinx XC3000[™], XC4000[™], XC5200[™], Spartan[®], Virtex[®] FPGAs, Motorola MPA1000 FPGAs
- Cascadable Read-back to Support Additional Configurations or Higher-density Arrays
- Low-power CMOS FLASH Process
- Available in 6 mm x 6 mm x 1 mm 8-lead LAP (Pin-compatible with 8-lead SOIC/VOIC Footprint Packages), 20-lead PLCC, 44-lead PLCC and 44-lead TQFP Packages
- Emulation of Atmel's AT24CXXX Serial EEPROMs
- Low-power Standby Mode
- Single Device Capable of Holding 4 Bit Stream Files Allowing Simple System Reconfiguration
- Fast Serial Download Speeds up to 33 MHz
- Endurance: 10,000 Write Cycles Typical

Description

The AT17F Series of In-System Programmable Configuration PROMs (Configurators) provide an easy-to-use, cost-effective configuration memory for Field Programmable Gate Arrays. The AT17F Series device is packaged in the 8-lead LAP, 20-lead PLCC, 44-lead PLCC and 44-lead TQFP, see Table 1. The AT17F Series Configurator uses a simple serial-access procedure to configure one or more FPGA devices.

The AT17F Series Configurators can be programmed with industry-standard programmers, Atmel's ATDH2200E Programming Kit or Atmel's ATDH2225 ISP Cable.

 Table 1. AT17F Series Packages

Package	AT17F16
8-lead LAP	Yes
20-lead PLCC	Yes
44-lead PLCC	Yes
44-lead TQFP	Yes



FPGA Configuration Flash Memory

AT17F16

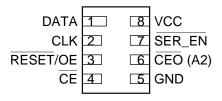
Advance Information



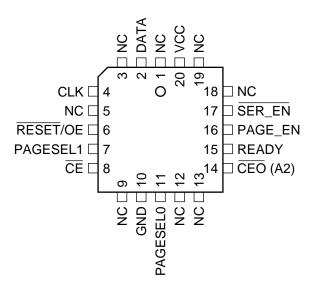


Pin Configuration

8-lead LAP

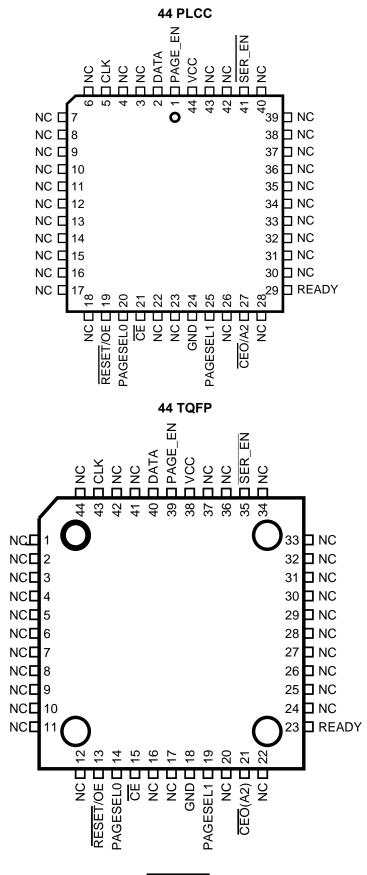


20-lead PLCC



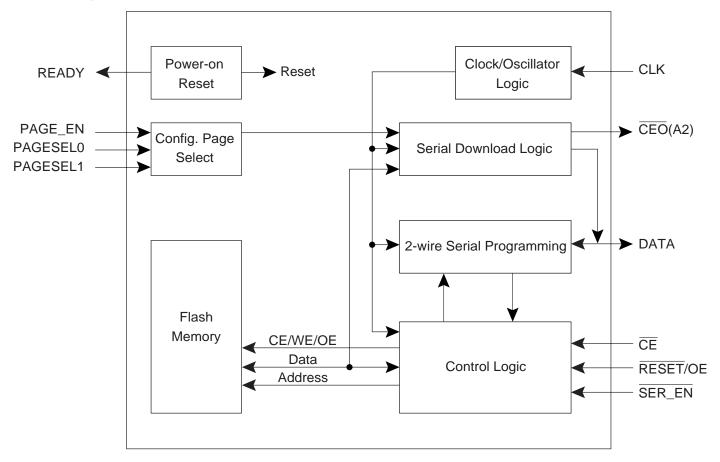
2

AT17F16





Block Diagram



Device Description

The control signals for the configuration memory device (\overline{CE} , \overline{RESET} /OE and CLK) interface directly with the FPGA device control signals. All FPGA devices can control the entire configuration process and retrieve data from the configuration device without requiring an external intelligent controller.

The RESET/OE and CE pins control the tri-state buffer on the DATA output pin and enable the address counter. When RESET/OE is driven Low, the configuration device resets its address counter and tri-states its DATA pin. The CE pin also controls the output of the AT17F Series Configurator. If CE is held High after the RESET/OE reset pulse, the counter is disabled and the DATA output pin is tri-stated. When OE is subsequently driven High, the counter and the DATA output pin are enabled. When RESET/OE is driven Low again, the address counter is reset and the DATA output pin is tri-stated, regardless of the state of CE.

When the configurator has driven out all of its data and \overline{CEO} is driven Low, the device tri-states the DATA pin to avoid contention with other configurators. Upon power-up, the address counter is automatically reset.

4

Pin Description

		AT17F16			
Name	I/O	8 LAP	20 PLCC	44 PLCC	44 TQFP
DATA	I/O	1	2	2	40
CLK	I	2	4	5	43
PAGE_EN	I	_	16	1	39
PAGESEL0	I	_	11	20	14
PAGESEL1	I	_	7	25	19
RESET/OE	I	3	6	19	13
CE	I	4	8	21	15
GND	_	5	10	24	18
CEO	0	6	4.4	07	04
A2	I	Ö	14	27	21
READY	0	_	15	29	23
SER_EN	I	7	17	41	35
V _{CC}	_	8	20	44	38

DATA⁽¹⁾

CLK⁽¹⁾

Three-state DATA output for configuration. Open-collector bi-directional pin for programming.

Clock input. Used to increment the internal address and bit counter for reading and programming.

PAGE_EN⁽²⁾

Input used to enable page download mode. When PAGE_EN is high the configuration download address space is partitioned into 4 equal pages. This gives users the ability to easily store and retrieve multiple configuration bitstreams from a single configuration device. This input works in conjunction with the PAGESEL inputs. PAGE_EN must be remain low if paging is not desired. When SER_EN is Low (ISP mode) this pin has no effect.

Notes: 1. This pin has an internal 20 K Ω pull-up resistor.

2. This pin has an internal 30 K Ω pull-down resistor.



AMEL

PAGESEL[1:0]⁽²⁾

Page select inputs. Used to determine which of the 4 memory pages are targeted during a serial configuration download. The address space for each of the pages is shown in Table 2. When SER_EN is Low (ISP mode) these pins have no effect.

Table 2. Address Space

Paging Decodes	AT17F16 (16 Mbits)
PAGESEL = 00, PAGE_EN = 1	00000 – 3FFFFh
PAGESEL = 01, PAGE_EN = 1	40000 – 7FFFh
PAGESEL = 10, PAGE_EN = 1	80000 – BFFFFh
PAGESEL = 11, PAGE_EN = 1	C0000 – FFFFh
PAGESEL = XX, PAGE_EN = 0	00000 – FFFFh

RESET/OE⁽¹⁾

Output Enable (active High) and RESET (active Low) when SER_EN is High. A Low level on RESET/OE resets both the address and bit counters. A High level (with CE Low) enables the data output driver.

- **CE**⁽¹⁾ Chip Enable input (active Low). A Low level (with OE High) allows CLK to increment the address counter and enables the data output driver. A High level on CE disables both the address and bit counters and forces the device into a low-power standby mode. Note that this pin will *not* enable/disable the device in the 2-wire Serial Programming mode (SER_EN Low).
- **GND** Ground pin. A 0.2 µF decoupling capacitor between V_{CC} and GND is recommended.

CEO Chip Enable Output (when SER_EN is High). This output goes Low when the internal address counter has reached its maximum value. If the PAGE_EN input is set High, the maximum value is the highest address in the selected partition. The PAGESEL[1:0] inputs are used to make the 4 partition selections. If the PAGE_EN input is set Low, the device is not partitioned and the address maximum value is the highest address in the device, see Table 2 on page 6. In a daisy chain of AT17F Series devices, the CEO pin of one device must be connected to the CE input of the next device in the chain. It will stay Low as long as CE is Low and OE is High. It will then follow CE until OE goes Low; thereafter, CEO will stay High until the entire EEPROM is read again.

A2⁽¹⁾ Device selection input, (when SER_EN Low). The input is used to enable (or chip select) the device during programming (i.e., when SER_EN is Low). Refer to the AT17F Programming Specification available on the Atmel web site for additional details.

READYOpen collector reset state indicator. Driven Low during power-up reset, released when
power-up is complete. (recommended 4.7 kΩ pull-up on this pin if used).

SER_EN⁽¹⁾

V_{cc}

The serial enable input must remain High during FPGA configuration operations. Bringing SER_EN Low enables the 2-Wire Serial Programming Mode. For non-ISP applications, SER_EN should be tied to V_{CC} .

+3.3V (±10%).

Notes: 1. This pin has an internal 20 K Ω pull-up resistor.

2. This pin has an internal 30 K Ω pull-down resistor.

6 AT17F16

AT17F16

FPGA Master Serial
Mode Summary

The I/O and logic functions of any SRAM-based FPGA are established by a configuration program. The program is loaded either automatically upon power-up, or on command, depending on the state of the FPGA mode pins. In Master mode, the FPGA automatically loads the configuration program from an external memory. The AT17F Serial Configuration PROM has been designed for compatibility with the Master Serial mode.

This document discusses the Atmel AT40K, AT40KAL and AT94KAL applications as well as Xilinx applications.

Control of Configuration

Most connections between the FPGA device and the AT17F Serial Configurator PROM are simple and self-explanatory.

- The DATA output of the AT17F Series Configurator drives DIN of the FPGA devices.
- The master FPGA CCLK output drives the CLK input of the AT17F Series Configurator.
- The CEO output of any AT17F Series Configurator drives the CE input of the next Configurator in a cascade chain of configurator devices.
- SER_EN must be connected to V_{CC} or allowed to float to logic High via the internal pull-up resistor (except during ISP).
- The READY pin is available as an open-collector indicator of the device's reset status; it is driven Low while the device is in its power-on reset cycle and released (tri-stated) when the cycle is complete.
- PAGE_EN must be held Low if download paging is not desired. The PAGESEL[1:0] inputs must be tied off High or Low. If paging is desired, PAGE_EN must be High and the PAGESEL pins must be set to High or Low such that the desired page is selected, see Table 2 on page 6.

Cascading SerialFor multiple FPGAs configured as a daisy-chain, or for FPGAs requiring larger configu-
ration memories, cascaded configurators provide additional memory.

After the last bit from the first configurator is read, the clock signal to the configurator asserts its CEO output Low and disables its DATA line driver. The second configurator recognizes the Low level on its CE input and enables its DATA output.

After configuration is complete, the address counters of all cascaded configurators are reset if the RESET/OE on each configurator is driven to its active (Low) level.

If the address counters are not to be reset upon completion, then the RESET/OE input can be tied to its inactive (High) level.

Programming Mode The programming mode is entered by bringing SER_EN Low. In this mode the chip can be programmed by the 2-wire serial bus. The programming is done at V_{CC} supply only. Programming super voltages are generated inside the chip. The AT17F parts are read/write at 3.3V nominal. Refer to the AT17F Programming Specification available on the Atmel web site (www.atmel.com) for more programming details. AT17F devices are supported by the Atmel ATDH2200E programming system along with many third party programmers.

Standby Mode The AT17F Series Configurators enter a low-power standby mode whenever SER_EN is High and CE is asserted High. In this mode, the AT17F Configurator consumes less than 5 mA of current at 3.6V. The output remains in a high-impedance state regardless of the state of the OE input.



Devices



Absolute Maximum Ratings*

Operating Temperature40°C to +85°C
Storage Temperature65°C to +150°C
Voltage on Any Pin with Respect to Ground0.1V to V_{CC} +0.5V
Supply Voltage (V $_{\rm CC}$)0.5V to +4.0V
Maximum Soldering Temp. (10 sec. @ 1/16 in.)260°C
ESD (R _{ZAP} = 1.5K, C _{ZAP} = 100 pF)

*NOTICE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those listed under operating conditions is not implied. Exposure to Absolute Maximum Rating conditions for extended periods of time may affect device reliability.

Operating Conditions

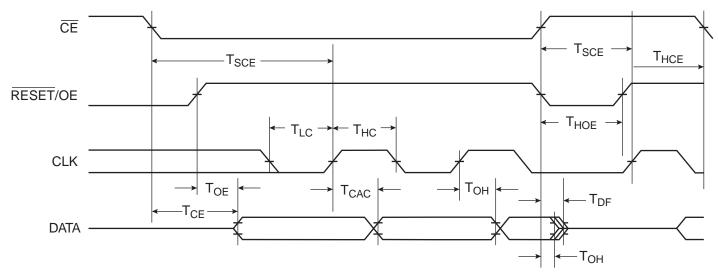
			AT17F Series	Configurator	
Symbol	Description		Min	Max	Units
	Commercial	Supply voltage relative to GND -0°C to +70°C	2.97	3.63	V
V _{cc}	Industrial	Supply voltage relative to GND -40°C to +85°C	2.97	3.63	V

DC Characteristics

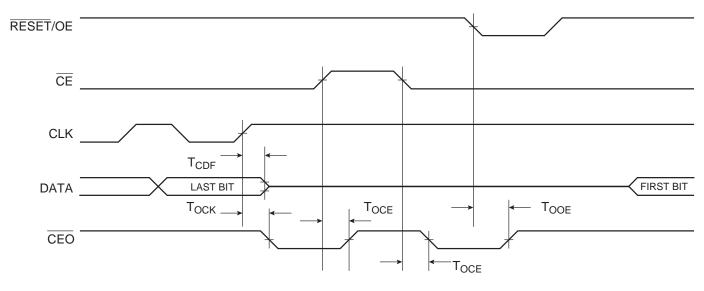
			AT17F16		
Symbol	Description		Min	Max	Units
V _{IH}	High-level Input Voltage		2.0	V _{cc}	V
V _{IL}	Low-level Input Voltage		0	0.8	V
V _{OH}	High-level Output Voltage (I _{OH} = -2.5 mA)	Oceanical	2.4		V
V _{OL}	Low-level Output Voltage (I _{OL} = +3 mA)	Commercial		0.4	V
V _{OH}	High-level Output Voltage (I _{OH} = -2 mA)	Inductrial	2.4		V
V _{OL}	Low-level Output Voltage (I _{OL} = +3 mA)	Industrial		0.4	V
I _{CCA}	Supply Current, Active Mode (3.6V 33 MHz)			40	mA
IL	Input or Output Leakage Current (V _{IN} = V _{CC} or GN	ID)	-10	10	μA
I _{CCS}	Quere la Quere et Otare d'au Ma de	Commercial		2	mA
	Supply Current, Standby Mode	Industrial		2	mA

8

AC Characteristics



AC Characteristics when Cascading







AC Characteristics

			AT17F16		
Symbol	Description		Min	Мах	Units
T (2)		Commercial		50	ns
T _{OE} ⁽²⁾	OE to Data Delay	Industrial ⁽¹⁾		55	ns
T (2)		Commercial		55	ns
T _{CE} ⁽²⁾	CE to Data Delay	Industrial ⁽¹⁾		60	ns
T (2)		Commercial	3	30	ns
T _{CAC} ⁽²⁾	CLK to Data Delay	Industrial ⁽¹⁾		30	ns
Ŧ		Commercial	0		ns
Т _{ОН}	Data Hold from \overline{CE} , OE, or CLK	Industrial ⁽¹⁾	0		ns
T (3)		Commercial		15	ns
T _{DF} ⁽³⁾	CE or OE to Data Float Delay	Industrial ⁽¹⁾		15	ns
Ŧ		Commercial	15		ns
T _{LC}	CLK Low Time	Industrial ⁽¹⁾	15		ns
Ŧ	T _{HC} CLK High Time	Commercial	15		ns
I _{HC}		Industrial ⁽¹⁾	15		ns
Ŧ	CE Setup Time to CLK	Commercial	20		ns
T _{SCE}	(to guarantee proper counting)	Industrial ⁽¹⁾	25		ns
Ŧ	CE Hold Time from CLK	Commercial	0		ns
T _{HCE}	(to guarantee proper counting)	Industrial ⁽¹⁾	0		ns
Ŧ	Reset/OE Low Time	Commercial	20		ns
T _{HOE}	(guarantees counter is reset)	Industrial ⁽¹⁾	20		ns
F	Maximum Input Clock Frequency	Commercial		10	MHz
F _{MAX}	SEREN = 0	Industrial ⁽¹⁾		10	MHz
F	Maximum Input Clock Frequency	Commercial		33	MHz
F _{MAX}	MAX SEREN = 1	Industrial ⁽¹⁾		33	MHz
т		Commercial		30	μs
T _{WR}	Write Cycle Time ⁽⁴⁾	Industrial ⁽¹⁾		30	μs
т	Franc Cycla Time ⁽⁴⁾	Commercial		60	s
T _{EC}	Erase Cycle Time ⁽⁴⁾	Industrial ⁽¹⁾		60	S

Notes: 1. Preliminary specifications for military operating range only.

2. AC test lead = 50 pF.

3. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady-state active levels.

4. See the AT17F Programming Specification for procedural information.

AC Characteristics When Cascading

			AT1	7F16	
Symbol	Description		Min	Max	Units
T (3)		Commercial		50	ns
T _{CDF} ⁽³⁾	CLK to Data Float Delay	Industrial		50	ns
T (2)	T (2) 011/(1 2550 D 1	Commercial		50	ns
T _{OCK} ⁽²⁾	CLK to CEO Delay	Industrial		55	ns
T (2)		Commercial		35	ns
OCE'	$T_{OCE}^{(2)}$ \overline{CE} to \overline{CEO} Delay	Industrial		40	ns
T (2)	RESET/OE to CEO Delay	Commercial		35	ns
T _{OOE} ⁽²⁾ RESET/OE to CEO Delay	Industrial		35	ns	
F _{MAX}		Commercial		33	MHz
	Maximum Input Clock Frequency Industrial		33	MHz	

Notes: 1. AC test lead = 50 pF.

2. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady-state active levels.





Thermal Resistance Coefficients

Package	Package Type		AT17F16
8CN4 Leadless Array Package (LAP)		θ _{JC} [°C/W]	_
	$\theta_{JA} \ [^{\circ}C/W]^{(1)}$	_	
20 L Diastia Londod Chin Corrier (DLCC)	θ _{JC} [°C/W]	_	
20J	20J Plastic Leaded Chip Carrier (PLCC)	$\theta_{JA} [^{\circ}C/W]^{(1)}$	_
444	44A Thin Plastic Quad Flat Package (TQFP)	θ _{JC} [°C/W]	17
44A		θ _{JA} [°C/W] ⁽¹⁾	62
	Plastic Looded Chip Corrige (PLCC)	θ _{JC} [°C/W]	15
44J	Plastic Leaded Chip Carrier (PLCC)	θ _{JA} [°C/W] ⁽¹⁾	50

Note: 1. Airflow = 0 ft/min.

Ordering Information

Memory Size	Ordering Code	Package	Operation Range
16-Mbit	AT17F16-30CC AT17F16-30JC AT17F16-30TQC AT17F16-30BJC	8CN4 - 8 LAP 20J - 20 PLCC 44A - 44 TQFP 44J - 44 PLCC	Commercial (0°C to 70°C)
	AT17F16-30Cl AT17F16-30Jl AT17F16-30TQl AT17F16-30BJl	8CN4 - 8 LAP 20J - 20 PLCC 44A - 44 TQFP 44J - 44 PLCC	Industrial (-40°C to 85°C)

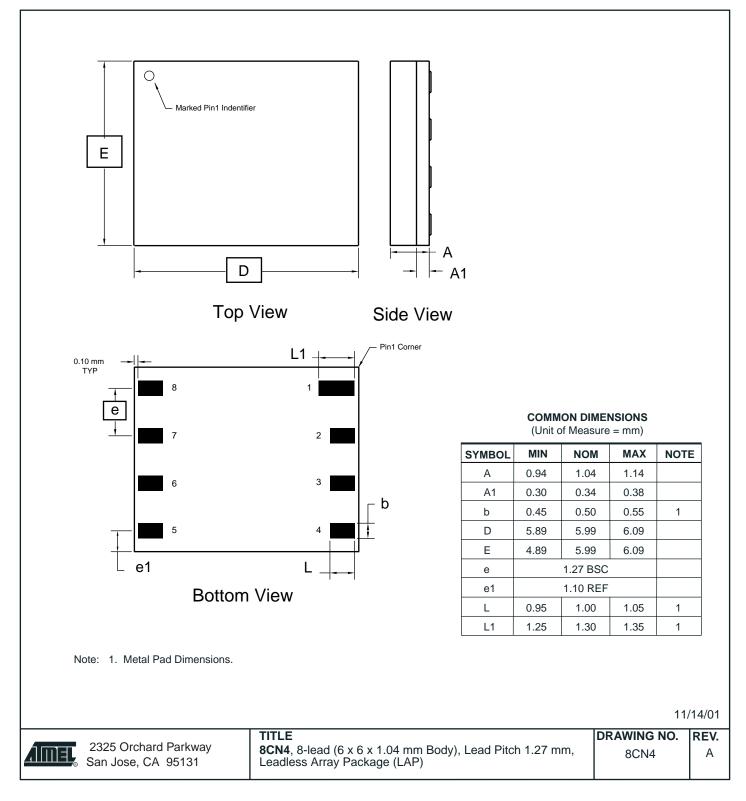
Package Type		
8CN4	8-lead, 6 mm x 6 mm x 1 mm, Leadless Array Package (LAP) – Pin-compatible with 8-lead SOIC/VOID Packages	
20J	20-lead, Plastic J-leaded Chip Carrier (PLCC)	
44A	44-lead, Thin (1.0 mm) Plastic Quad Flat Package Carrier (TQFP)	
44J	44-lead, Plastic J-leaded Chip Carrier (PLCC)	



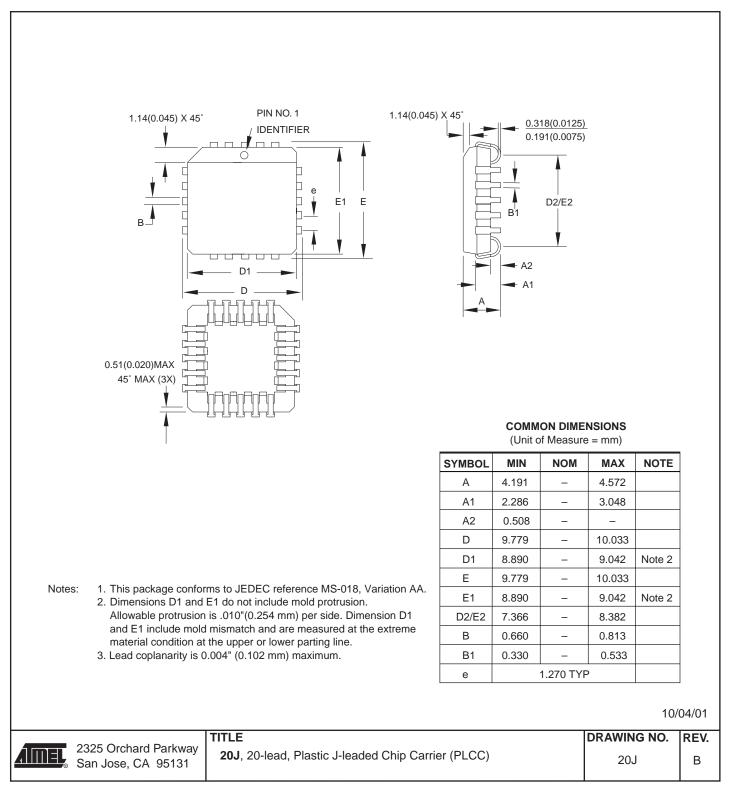


Packaging Information

8CN4 – LAP



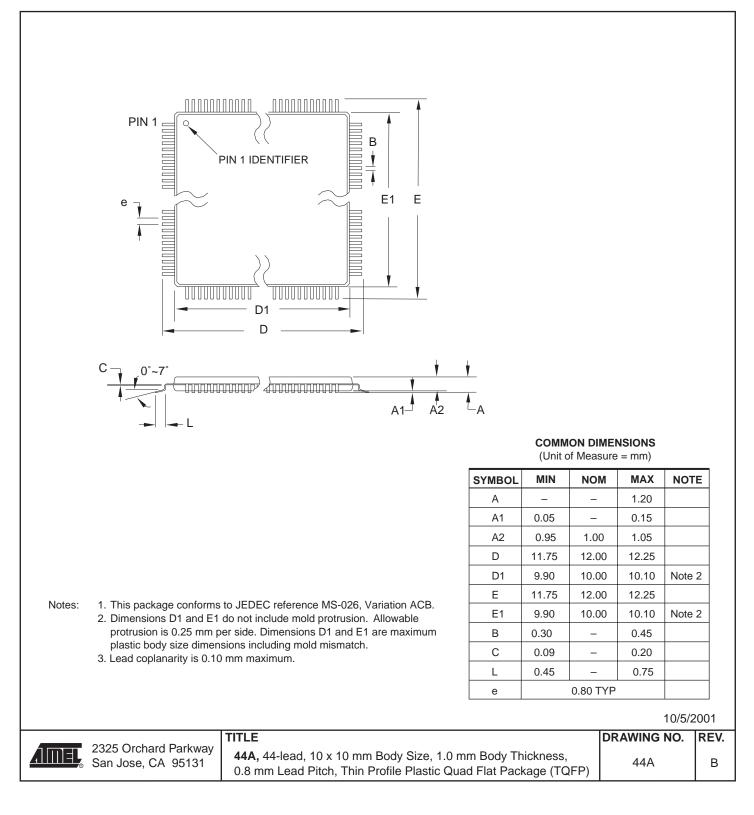
20J – PLCC



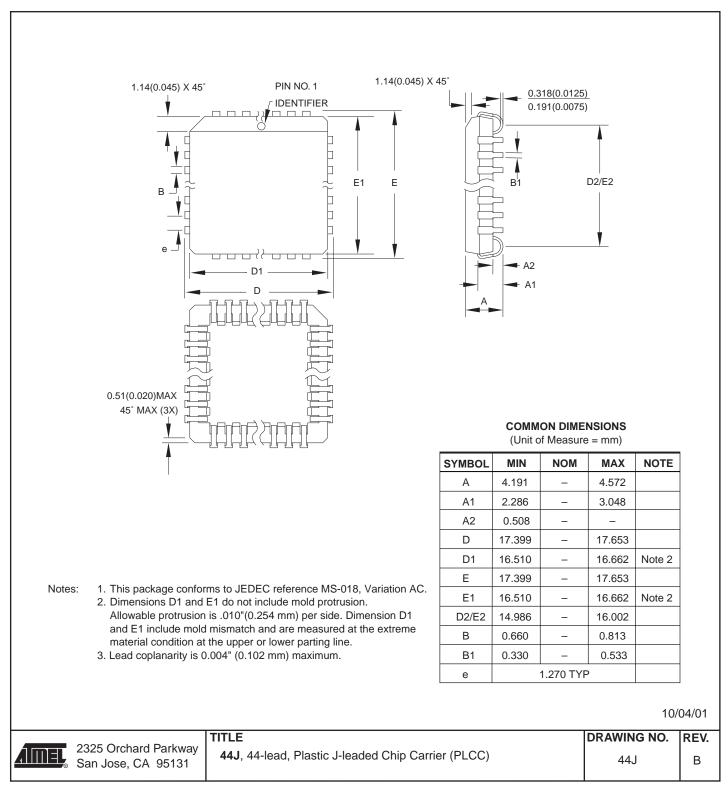




44A – TQFP



44J – PLCC







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